PRM012N10S8

PFC Device Corporation

100V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	100	**V**
I_D (T_A=25°C)	10.7	**A**
Max. $R_{DS(ON)}$@V_{GS}=10V	12	**mΩ**
Max. $R_{DS(ON)}$@V_{GS}=4.5V	15	**mΩ**
T_J Operating Junction Temperature	-55 to +150	**°C**

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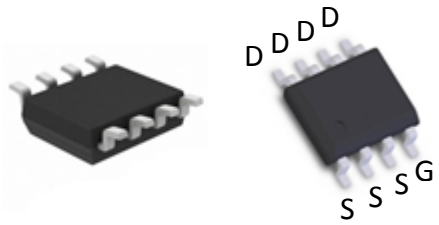
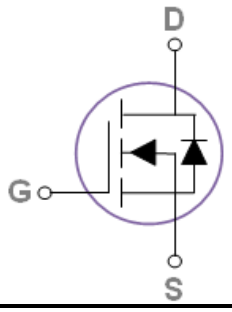


SOP-8



General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.

Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. $R_{DS(ON)}$=12mΩ@V_{GS}=10V
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

1. Characteristics

Maximum Ratings Characteristics (T_A = 25 °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current – Continuous (T_A=25°C)	10.7	A
	Drain Current – Continuous (T_A=100°C)	6.7	A
I_{DM}	Drain Current – Pulsed[1]	42.8	A
E_{AS}	Single Pulse Avalanche Energy[2]	58	mJ
I_{AS}	Single Pulse Avalanche Current[2]	17	A
P_D	Power Dissipation (T_A=25°C)	2.5	W
	Power Dissipation – Derate above 25°C	0.02	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	50	°C/W

Electrical Characteristics (T_J = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	100	---	---	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=100V, V_{GS}=0V, T_J=25°C	---	---	1	uA
		V_{DS}=100V, V_{GS}=0V, T_J=125°C	---	---	250	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0V	---	---	±100	nA

On Characteristics

$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=10V, I_D=5A	---	---	12	mΩ
		V_{GS}=4.5V, I_D=3A	---	---	15	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS}=V_{DS}, I_D=250uA	1.0	---	2.5	V
g_{fs}	Forward Transconductance	V_{DS}=5V, I_D=5A	---	25	---	S

Dynamic and switching Characteristics

Q_g	Total Gate Charge[3,4]	V_{DS}=50V, V_{GS}=10V, I_D=10.7A	---	36.5	---	nC
Q_{gs}	Gate-Source Charge[3,4]		---	6.5	---	
Q_{gd}	Gate-Drain Charge[3,4]		---	6.5	---	
$T_{d(on)}$	Turn-On Delay Time[3,4]	V_{DD}=50V, V_{GS}=10V, R_G=6Ω I_D=10.7A	---	14	---	ns
T_r	Turn-On Rise Time[3,4]		---	42	---	
$T_{d(off)}$	Turn-Off Delay Time[3,4]		---	41	---	
T_f	Turn-Off Fall Time[3,4]		---	82	---	
C_{iss}	Input Capacitance	V_{DS}=25V, V_{GS}=0V, f=1MHz	---	2200	---	pF
C_{oss}	Output Capacitance		---	210	---	
C_{rss}	Reverse Transfer Capacitance		---	30	---	
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	---	1.6	---	Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	V_{GS}=0V, I_S=10.7A	---	---	1.5	V
t_{rr}	Reverse Recovery Time	I_S=10.7A, di/dt=100A/us	---	46	---	ns
Q_{rr}	Reverse Recovery Charge		---	63	---	nC

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=27A, R_G=25Ω, Starting T_J=25°C
3. The data tested by pulsed, pulse width ≦300us, duty cycle ≦2%.
4. Essentially independent of operating temperature.

2. Characteristics Curves

Ratings and Characteristics Curves **(T_A = 25℃ unless otherwise specified)**

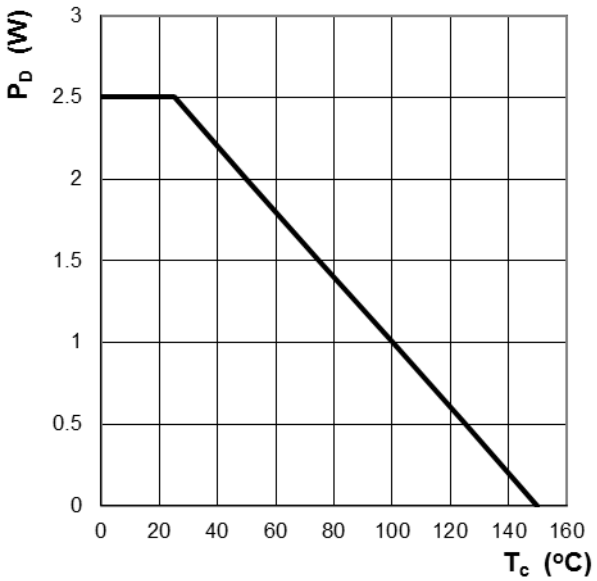


Figure 1: Power Dissipation

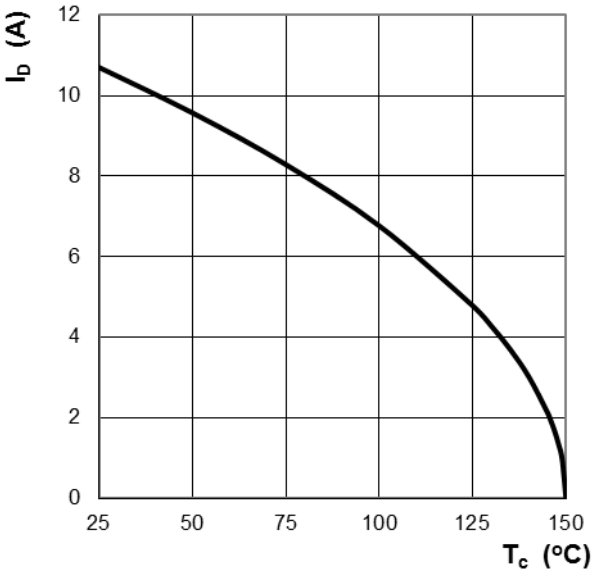


Figure 2: Continuous Drain Current vs. T_C

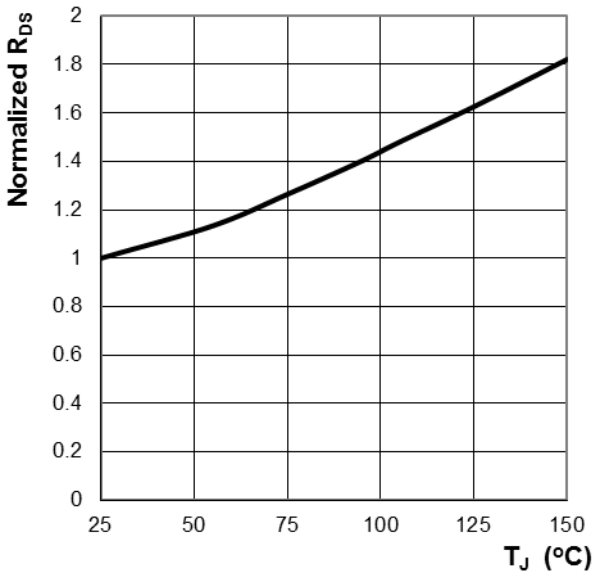


Figure 3: Normalized $R_{DS(ON)}$ vs. T_J

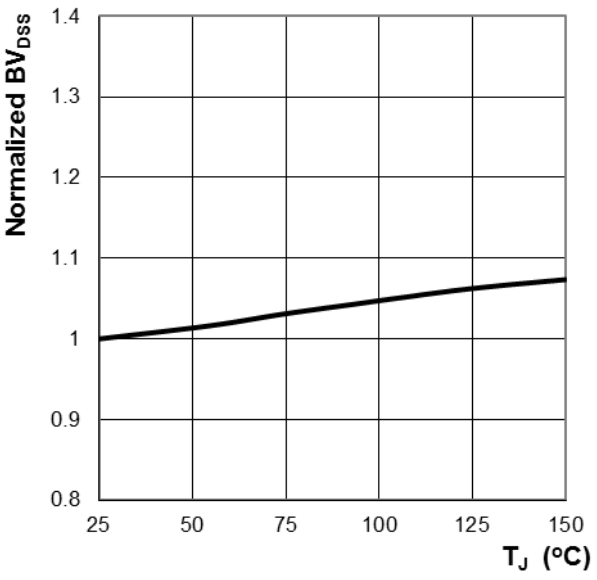


Figure 4: Normalized BV_{DSS} vs. T_J

Ratings and Characteristics Curves **(T_A = 25℃ unless otherwise specified)**

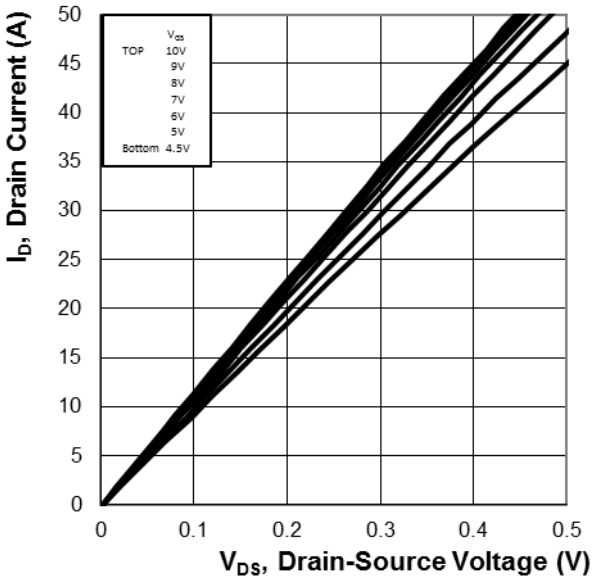


Figure 5: On-Region Characteristics

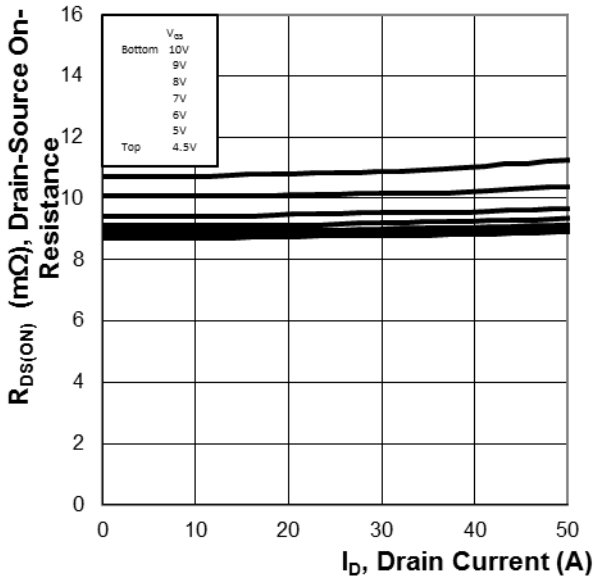


Figure 6: Typ. R_{DS} Variation vs. I_D and V_{GS}

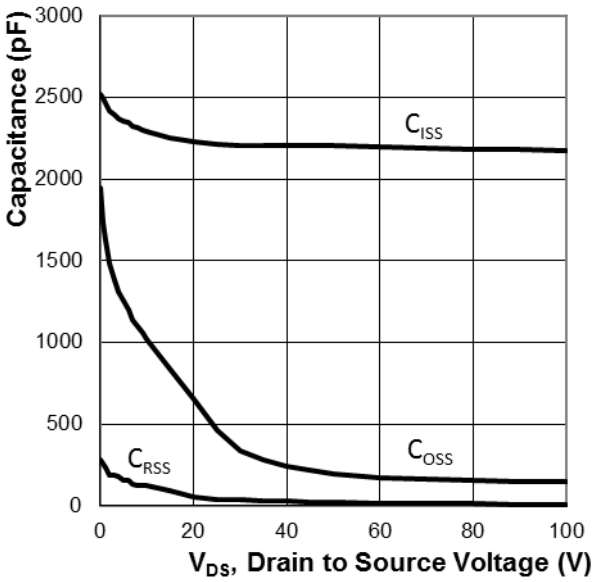


Figure 7: Typ. Capacitance Characteristics

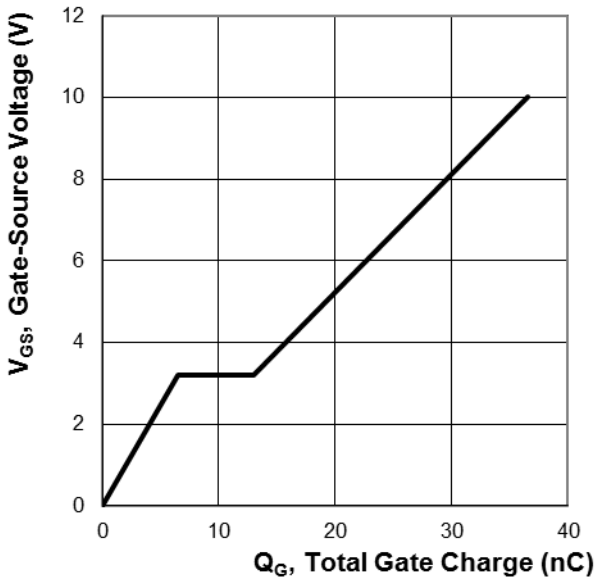


Figure 8: Typ. Gate Charge Characteristics

Ratings and Characteristics Curves **(T_A = 25℃ unless otherwise specified)**

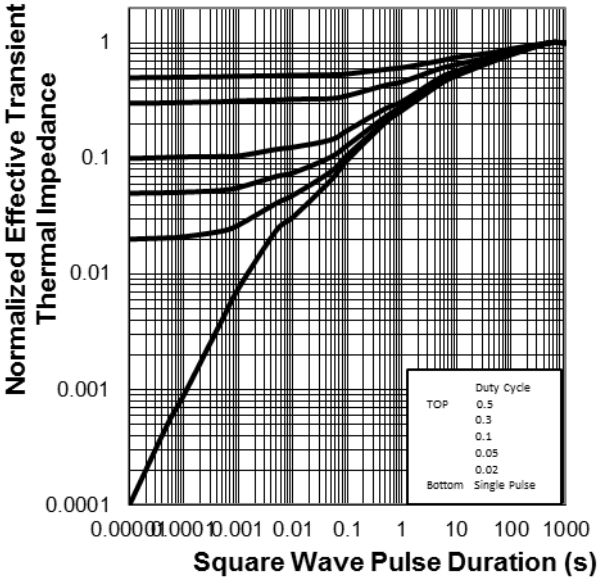


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

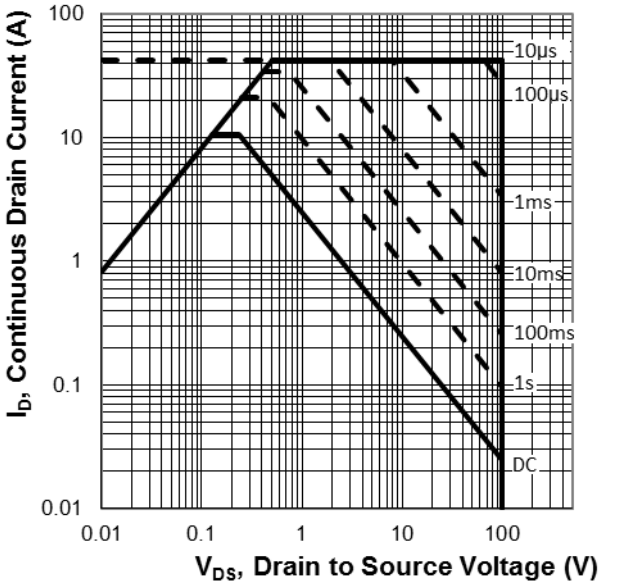


Figure 10: Maximum Safe Operation Area

3. Marking information

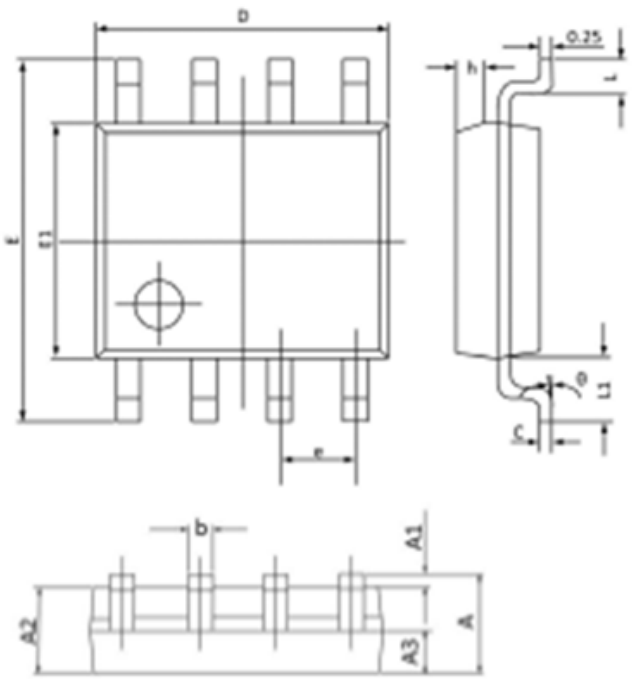
Top Marking Rule

PFC PRM
012N10S8
YYWW ABSH

PRM012N10S8 = Product Type Marking Code
YYWW = Date Code
YY = Last two digits of year
WW = Week code
ABS = Assembly code
H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters



Dim.	Min.	Max.
A	1.35	1.75
A1	0.10	0.25
A2	1.30	---
A3	0.60	0.70
b	0.35	0.49
c	0.18	0.26
D	4.70	5.10
E	5.80	6.20
E1	3.70	4.10
e	1.27 BSC	
h	0.25	0.50
L	0.40	0.90
L1	1.05 BSC	
θ	0°	8°
All Dimensions in mm		

5. Ordering information

Part Number	Package	Delivery mode
PRM012N10S8	SOP-8	3000 pcs / 13" diameter reel

Mechanical

- Molder Plastic : UL Flammability Classification Rating 94V-0
- Device Weight : 0.003 ounces (0.085grams) – SOP-8